

Product data sheet

1. General description

Planar passivated four quadrant triac in a SOT404 (D2PAK) surface-mountable plastic package intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

2. Features and benefits

- High blocking voltage capability
- Less sensitive gate for improved noise immunity
- Planar passivated for voltage ruggedness and reliability
- Surface-mountable package
- Triggering in all four quadrants

3. Applications

- General purpose motor controls
- General purpose switching

4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DRM}	repetitive peak off- state voltage		-	-	600	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{mb} \le 99 \text{ °C}$; <u>Fig. 1</u> ; <u>Fig. 2</u> ; <u>Fig. 3</u>	-	-	12	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; $T_{j(init)} = 25 \text{ °C};$ $t_p = 20 \text{ ms; } Fig. 4; Fig. 5$	-	-	95	A
		full sine wave; $T_{j(init)}$ = 25 °C; t _p = 16.7 ms	-	-	105	A
Tj	junction temperature		-	-	125	°C
Static chara	acteristics	·				
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 7</u>	-	5	35	mA
		V _D = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 7</u>	-	8	35	mA
		V _D = 12 V; I _T = 0.1 A; T2- G-; T _i = 25 °C; <u>Fig. 7</u>	-	10	35	mA

BT138B-600

4Q Triac

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
		V _D = 12 V; I _T = 0.1 A; T2- G+; T _j = 25 °C; <u>Fig. 7</u>		-	22	70	mA	
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>		-	6	30	mA	
V _T	on-state voltage	I _T = 15 A; T _j = 25 °C; <u>Fig. 10</u>		-	1.4	1.65	V	
Dynamic characteristics								
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit		100	250	-	V/µs	

5. Pinning information

Table 2. Pinning information									
Pin	Symbol	Description	Simplified outline	Graphic symbol					
1	T1	main terminal 1		N					
2	T2	main terminal 2		T2-T1 g sym051					
3	G	gate							
mb	Τ2	mounting base; main terminal 2							

6. Ordering information

Table 3. Ordering information									
Type number	Package	Orderable part number	Packing	Small packing	Package	Package			
	Name		method	quantity	version	issue date			
BT138B-600	TO263	BT138B-600,118	Reel	800	TO263N (N)	26-Sep-2016			
					TO263P (P)	12-Jun-2023			

7. Marking

Table 4. Marking codes				
Type number	Marking codes			
	Assembly factory: N	Assembly factory: P		
BT138B-600	BT138B 600 PJNxxxx xx	BT138B 600 PJPxxxx xx		

BT138B-600



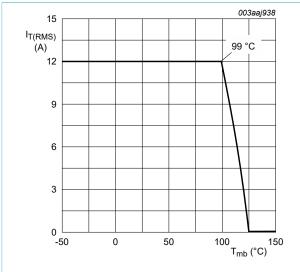
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8. Limiting values

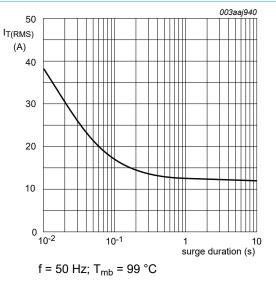
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	600	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{mb} ≤ 99 °C; <u>Fig. 1; Fig. 2;</u> <u>Fig. 3</u>	-	12	A
	non-repetitive peak on- state current	full sine wave; $T_{j(init)}$ = 25 °C; t_p = 20 ms; Fig. 4; Fig. 5	-	95	A
		full sine wave; T _{j(init)} = 25 °C; t _p = 16.7 ms	-	105	А
l ² t	I ² t for fusing	t _p = 10 ms; sine-wave pulse	-	45	A²s
dl _T /dt	rate of rise of on-state current	I _G = 150 mA	-	50	A/µs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C



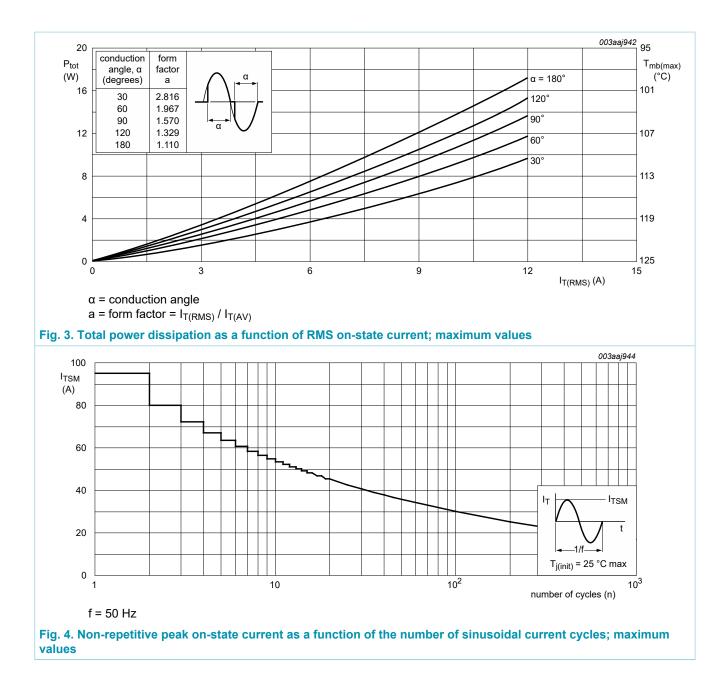






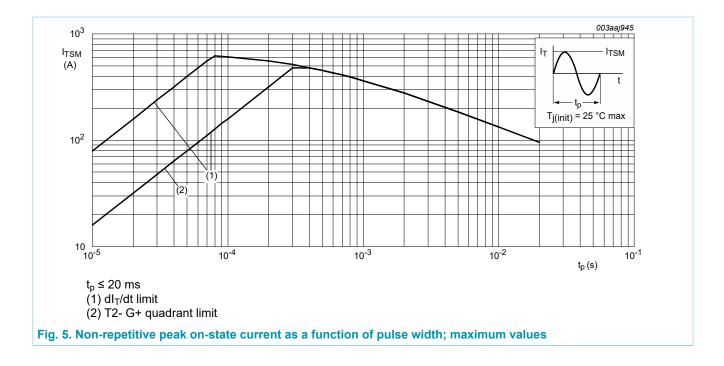
BT138B-600

4Q Triac



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4Q Triac



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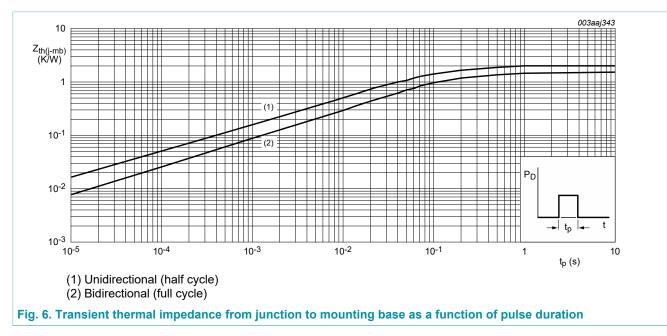
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BT138B-600

4Q Triac

9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance	full cycle; <u>Fig. 6</u>	-	-	1.5	K/W
	from junction to mounting base	half cycle; <u>Fig. 6</u>	-	-	2	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	minimum footprint: FR4 board	-	55	-	K/W



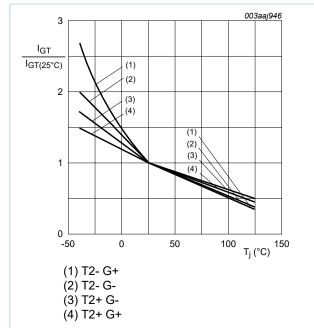
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10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 7</u>	-	5	35	mA
		V _D = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 7</u>	-	8	35	mA
		V _D = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 7</u>	-	10	35	mA
		V _D = 12 V; I _T = 0.1 A; T2- G+; T _j = 25 °C; <u>Fig. 7</u>	-	22	70	mA
ΙL	latching current	V _D = 12 V; I _G = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 8</u>	-	7	40	mA
		V _D = 12 V; I _G = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 8</u>	-	20	60	mA
		V _D = 12 V; I _G = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 8</u>	-	8	40	mA
		V _D = 12 V; I _G = 0.1 A; T2- G+; T _j = 25 °C; <u>Fig. 8</u>	-	10	60	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	6	30	mA
V _T	on-state voltage	I _T = 15 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.4	1.65	V
V _{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 11</u>	-	0.7	1	V
		V _D = 400 V; I _T = 0.1 A; T _j = 125 °C; <u>Fig. 11</u>	0.25	0.4	-	V
I _D	off-state current	V _D = 600 V; T _j = 125 °C	-	0.1	0.5	mA
Dynamic ch	naracteristics	· · · ·				
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	100	250	-	V/µs

BT138B-600

4Q Triac





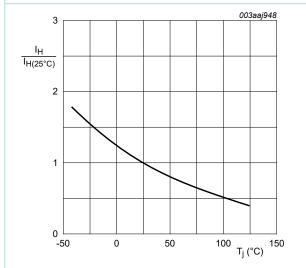
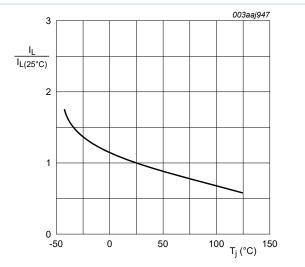
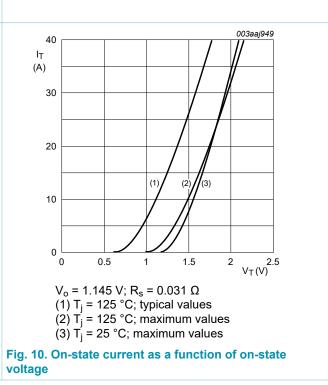


Fig. 9. Normalized holding current as a function of junction temperature

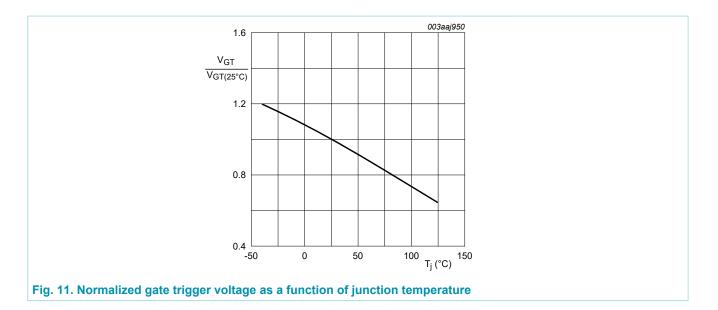






BT138B-600

4Q Triac

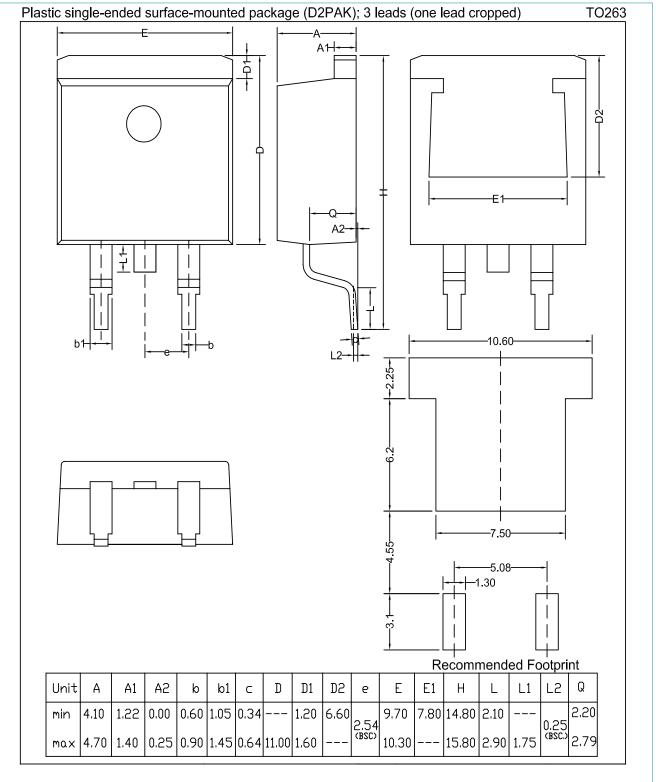


BT138B-600

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11. Package outline

Assembly factory: N



Assembly factory: P

$\overline{\begin{array}{c} \hline \\ \hline $	Plastic single-en	ded surf	àce-mo	ounted p	backage (D2PAK); 3 leads (one lead cropped)	TO263
MinTypMaxA4.304.464.60A100.130.25A22.502.602.70b0.700.800.90b11.101.271.45C0.400.520.60C11.171.301.40D9.109.259.40D11.001.101.30D27.407.708.00E9.8010.0010.20E17.607.808.00e $2.54 BSC$ H14.8015.3015.80L2.102.472.80			 C		C1	
	A A1 A2 b b1 C C C1 D D1 D1 D2 E E E1 e e H L	Min 4.30 0 2.50 0.70 1.10 0.40 1.17 9.10 1.00 7.40 9.80 7.60 14.80 2.10	Typ 4.46 0.13 2.60 0.80 1.27 0.52 1.30 9.25 1.10 7.70 10.00 7.80 2.54 BSC 15.30 2.47	Max 4.60 0.25 2.70 0.90 1.45 0.60 1.40 9.40 1.30 8.00 10.20 8.00 15.80 2.80		

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Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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BT138B-600 4Q Triac

13. Contents

1.	General description	1
2.	Features and benefit	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	3
9.	Thermal characteristics	6
10	. Characteristics	7
11.	Package outline1	0
12	. Legal information1	2

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